

May 2007

# DM74ALS257, DM74ALS258 3-STATE Quad 1-of-2-Line Data Selector/Multiplexer

#### **Features**

- Switching specifications at 50pF
- Switching specifications guaranteed over full temperature and V<sub>CC</sub> range
- Advanced oxide-isolated, ion-implanted Schottky TTL process
- Functionally and pin for pin compatible with Schottky and low power Schottky TTL counterpart
- Improved AC performance over Schottky and low power Schottky counterparts
- 3-STATE buffer-type outputs drive bus lines directly
- Expand any data input point
- Multiplex dual data buses
- General four functions of two variables (one variable is common)
- Source programmable counters

#### **General Description**

These data selectors/multiplexers contain inverters and drivers to supply full on-chip data selection to the four 3-STATE outputs that can interface directly with data lines of bus-organized systems. A 4-bit word selected from one of two sources is routed to the four outputs. The DM74ALS257 presents true data whereas the DM74ALS258 presents inverted data to minimize propagation delay time.

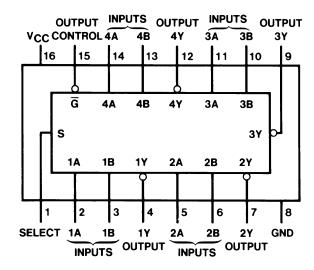
This 3-STATE output feature means that n-bit (paralleled) data selectors with up to 258 sources can be implemented for data buses. It also permits the use of standard TTL registers for data retention throughout the system.

## **Ordering Information**

Order Number	Package Number	Package Description
DM74ALS257M	M16A	16-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-012, 0.150" Narrow
DM74ALS257SJ	M16D	16-Lead Small Outline Package (SOP), EIAJ TYPE II, 5.3mm Wide
DM74ALS258M	M16A	16-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-012, 0.150" Narrow

Devices also available in Tape and Reel. Specify by appending the suffix letter "X" to the ordering number.

## **Connection Diagram**



#### **Function Table**

	Inputs	Out	out Y		
Output Control	Select	Α	В	DM74ALS257	DM74ALS258
Н	Х	Х	Х	Z	Z
L	L	L	Х	L	Н
L	L	Н	Х	Н	L
L	Н	X	L	L	Н
L	Н	Х	Н	Н	L

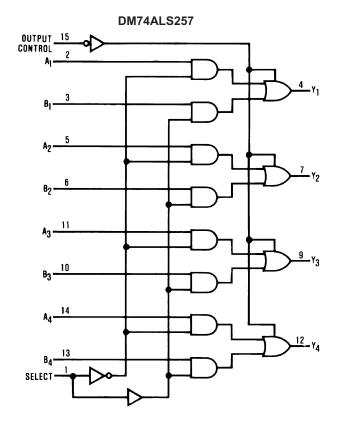
H = HIGH Level

L = LOW Level

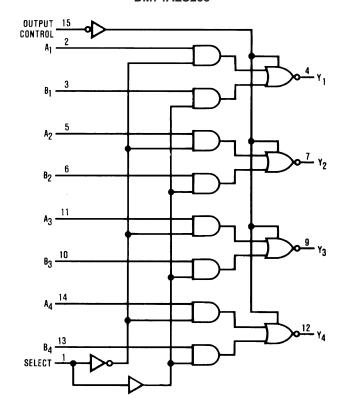
X = Don't Care

Z = High Impedance (OFF)

## **Logic Diagrams**



#### DM74ALS258



## **Absolute Maximum Ratings**

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only.

Symbol	Parameter	Rating		
V <sub>CC</sub>	Supply Voltage	7V		
VI	nput Voltage			
	Voltage Applied to Disabled Output	5.5V		
T <sub>A</sub>	Operating Free Air Temperature Range	0°C to +70°C		
T <sub>STG</sub>	Storage Temperature Range	–65°C to +150°C		
$\theta_{JA}$	Typical Thermal Resistance	102.0°C/W		

### **Recommended Operating Conditions**

The Recommended Operating Conditions table defines the conditions for actual device operation. Recommended operating conditions are specified to ensure optimal performance to the datasheet specifications. Fairchild does not recommend exceeding them or designing to absolute maximum ratings.

Symbol	Parameter	Min.	Nom.	Max.	Units
V <sub>CC</sub>	Supply Voltage	4.5	5	5.5	V
V <sub>IH</sub>	HIGH Level Input Voltage	2			V
V <sub>IL</sub>	LOW Level Input Voltage			0.8	V
I <sub>OH</sub>	HIGH Level Output Current			-2.6	mA
I <sub>OL</sub>	LOW Level Output Current			24	mA
T <sub>A</sub>	Free Air Operating Temperature	0		70	°C

#### **Electrical Characteristics**

Over recommended operating free air temperature range. All typical values are measured at  $V_{CC} = 5V$ ,  $T_A = 25^{\circ}C$ .

Symbol	Paran	neter	Conditions		Min.	Тур.	Max.	Units
V <sub>IK</sub>	Input Clamp Voltage		$V_{CC} = 4.5V, I_I = -18mA$				-1.5	V
V <sub>OH</sub>	HIGH Level Outp	out Voltage	V <sub>CC</sub> = 4.5V	$V_{CC} = 4.5V$ $I_{OH} = -2.6mA$	2.4	3.3		V
				$I_{OH} = -0.4$ mA	V <sub>CC</sub> – 2			
V <sub>OL</sub>	LOW Level Outp	ut Voltage	$V_{CC} = 4.5V$	I <sub>OL</sub> = 12mA		0.25	0.4	V
				$I_{OL} = 24mA$		0.35	0.5	
I <sub>I</sub>	I <sub>I</sub> Input Current at Maximum Input Voltage		$V_{CC} = 5.5V, V_{IH}$	= 7V			0.1	mA
I <sub>IH</sub>	HIGH Level Input Current		$V_{CC} = 5.5V, V_{IH} = 2.7V$				20	μA
I <sub>IL</sub>	LOW Level Input Current		$V_{CC} = 5.5V, V_{IL} = 0.4V$				-0.1	mA
Io	Output Drive Current		$V_{CC} = 5.5V, V_{O} = 2.25V$		-30		-112	mA
I <sub>OZH</sub>	OFF-State Output Current, HIGH Level Voltage Applied		$V_{CC} = 5.5V, V_O$	= 2.7V			20	μΑ
I <sub>OZL</sub>	OFF-State Output Current, LOW Level Voltage Applied		$V_{CC} = 5.5V, V_O$	= 0.4V			-20	μΑ
I <sub>CCH</sub>	Supply Current	DM74ALS257	$V_{CC} = 5.5V$ ,	Outputs HIGH		3	6	mA
		DM74ALS258	Outputs OPEN			2.5	4	
I <sub>CCL</sub>	Supply Current	DM74ALS257		Outputs LOW		8	12	mA
		DM74ALS258	]			7	11	
I <sub>CCZ</sub>	Supply Current	DM74ALS257		Outputs Disabled		9	14	mA
		DM74ALS258				8	13	

## **Switching Characteristics DM74ALS257**

Over recommended operating free air temperature range.

Symbol	Parameter	Conditions	From	То	Min.	Max.	Units
t <sub>PLH</sub>	Propagation Delay Time, LOW-to-HIGH Level Output	$V_{CC} = 4.5V \text{ to } 5.5V,$ $C_L = 50pF,$	Data	Any Y	2	10	ns
t <sub>PHL</sub>	Propagation Delay Time, HIGH-to-LOW Level Output	$R_L = 500\Omega$	Data	Any Y	2	12	ns
t <sub>PLH</sub>	Propagation Delay Time, LOW-to-HIGH Level Output		Select	Any Y	4	18	ns
t <sub>PHL</sub>	Propagation Delay Time, HIGH-to-LOW Level Output		Select	Any Y	5	22	ns
t <sub>ZH</sub>	Output Enable Time to HIGH Level		Output Control	Any Y	4	16	ns
t <sub>ZL</sub>	Output Enable Time to LOW Level		Output Control	Any Y	5	18	ns
t <sub>HZ</sub>	Output Disable Time from HIGH Level		Output Control	Any Y	2	10	ns
t <sub>LZ</sub>	Output Disable Time from LOW Level		Output Control	Any Y	3	15	ns

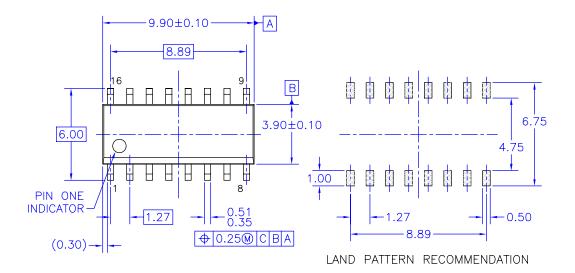
## **Switching Characteristics DM74ALS258**

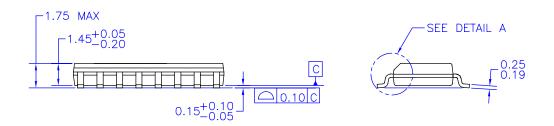
Over recommended operating free air temperature range.

Symbol	Parameter	Conditions	From	То	Min.	Max.	Units
t <sub>PLH</sub>	Propagation Delay Time, LOW-to-HIGH Level Output	$V_{CC} = 4.5V \text{ to } 5.5V,$ $C_{L} = 50pF,$	Data	Any Y	2	8	ns
t <sub>PHL</sub>	Propagation Delay Time, HIGH-to-LOW Level Output	$R_L = 500\Omega$	Data	Any Y	2	7	ns
t <sub>PLH</sub>	Propagation Delay Time, LOW-to-HIGH Level Output		Select	Any Y	3	20	ns
t <sub>PHL</sub>	Propagation Delay Time, HIGH-to-LOW Level Output		Select	Any Y	5	25	ns
t <sub>ZH</sub>	Output Enable Time to HIGH Level		Output Control	Any Y	5	18	ns
t <sub>ZL</sub>	Output Enable Time to LOW Level		Output Control	Any Y	5	18	ns
t <sub>HZ</sub>	Output Disable Time from HIGH Level		Output Control	Any Y	2	10	ns
$t_{LZ}$	Output Disable Time from LOW Level		Output Control	Any Y	3	18	ns

## **Physical Dimensions**

Dimensions are in millimeters unless otherwise noted.





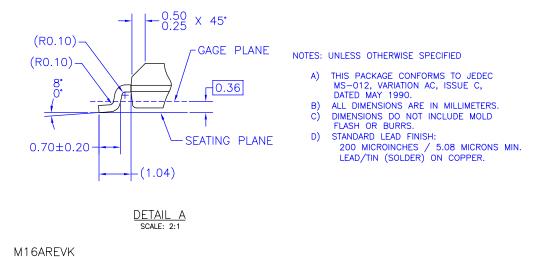
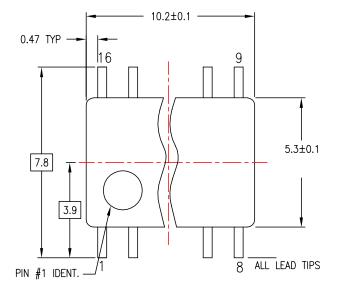
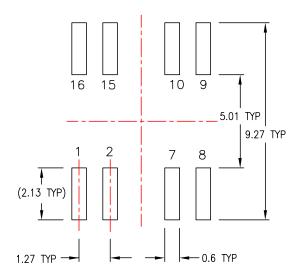


Figure 1. 16-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-012, 0.150" Narrow Package Number M16A

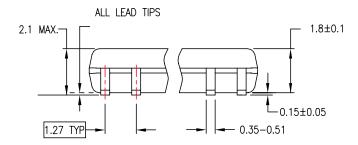
## Physical Dimensions (Continued)

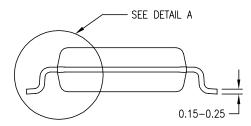
Dimensions are in millimeters unless otherwise noted.





#### LAND PATTERN RECOMMENDATION





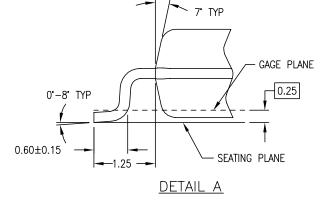
#### DIMENSIONS ARE IN MILLIMETERS

#### NOTES:

- A. CONFORMS TO EIAJ EDR-7320 REGISTRATION,
- ESTABLISHED IN DECEMBER, 1998.

  B. DIMENSIONS ARE IN MILLIMETERS.

  C. DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH, AND TIE BAR EXTRUSIONS.



M16DREVC

Figure 2. 16-Lead Small Outline Package (SOP), EIAJ TYPE II, 5.3mm Wide Package Number M16D





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